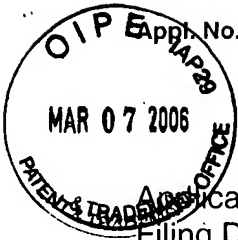


03-09-06

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App. No. 10/614,807

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Application Serial No. ....10/614,807  
Filing Date ..... July 9, 2003  
Inventor.....Wuwen Yi et al.  
Assignee.....Honeywell International Inc.  
Group Art Unit.....1742  
Examiner .....Wilkins, Harry D.  
Attorney's Docket No. .... H0004116-US  
Customer No. ....021567  
Title: Copper Sputtering Targets and Methods of Forming Copper Sputtering Targets

**RESPONSE TO DECEMBER 8, 2005 OFFICE ACTION**

To: Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

From: Jennifer J. Taylor, Ph.D. (Tel. 509-624-4276; Fax 509-838-3424)  
Wells St. John P.S.  
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**AMENDMENTS**

**Introductory Comments**

In reply to the Office Action of December 8, 2005, applicant amends and remarks as follows.